

TOSHIBA**2SK2267**TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (L^2 - π -MOSV)**2SK2267**

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

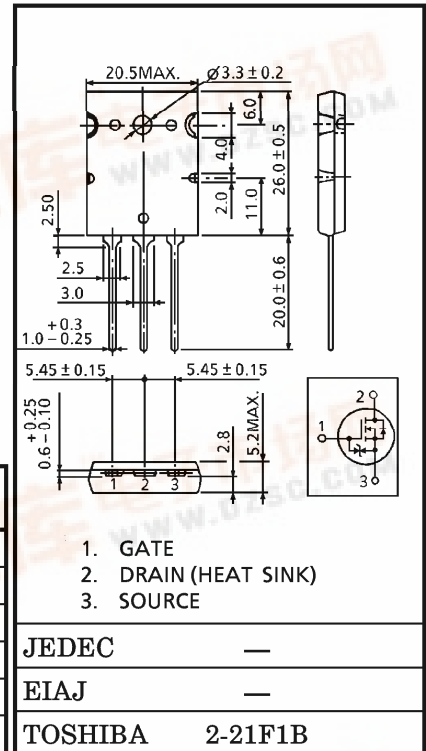
INDUSTRIAL APPLICATIONS

Unit in mm

- 4 V Gate Drive
- Low Drain-Source ON Resistance : $R_{DS(ON)} = 8 \text{ m}\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 60 \text{ S}$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100 \mu\text{A}$ (Max.) ($V_{DS} = 60 \text{ V}$)
- Enhancement-Mode : $V_{th} = 0.8 \sim 2.0 \text{ V}$
($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Drain-Gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	60	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	DC	I_D	60	A
	Pulse	I_{DP}	240	A
Drain Power Dissipation ($T_c = 25^\circ\text{C}$)		P_D	150	W
Single Pulse Avalanche Energy**		E_{AS}	1054	mJ
Avalanche Current		I_{AR}	60	A
Repetitive Avalanche Energy*		E_{AR}	15	mJ
Channel Temperature		T_{ch}	150	$^\circ\text{C}$
Storage Temperature Range		T_{stg}	$-55 \sim 150$	$^\circ\text{C}$



Weight : 9.75 g

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel To Case	$R_{th(ch-c)}$	0.833	$^\circ\text{C/W}$
Thermal Resistance, Channel To Ambient	$R_{th(ch-a)}$	35.7	$^\circ\text{C/W}$

Note ;

* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

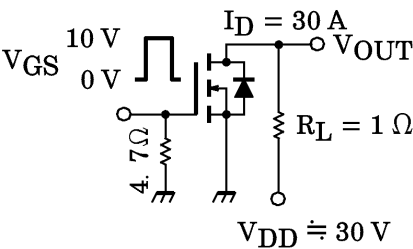
** $V_{DD} = 25 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 398 \mu\text{H}$, $R_G = 25 \Omega$, $I_{AR} = 60 \text{ A}$

This transistor is an electrostatic sensitive device.
Please handle with caution.

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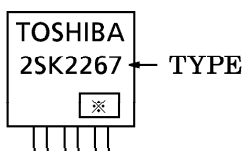
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	± 10	μA
Drain Cut-off Current		I_{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	100	μA
Drain-Source Breakdown Voltage		$V_{(BR) DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	60	—	—	V
Gate Threshold Voltage		V_{th}	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	0.8	—	2.0	V
Drain-Source ON Resistance		$R_{DS(ON)}$	$V_{GS} = 4 \text{ V}, I_D = 30 \text{ A}$	—	12	15	$\text{m}\Omega$
			$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$	—	8	11	
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}, I_D = 30 \text{ A}$	40	60	—	S
Input Capacitance		C_{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	5400	—	pF
Reverse Transfer Capacitance		C_{rss}		—	920	—	
Output Capacitance		C_{oss}		—	2600	—	
Switching Time	Rise Time	t_r	 $V_{GS} = 10 \text{ V}$ $V_{GS} = 0 \text{ V}$ $I_D = 30 \text{ A}$ $R_L = 1 \Omega$ $V_{DD} \approx 30 \text{ V}$	—	30	—	ns
	Turn-on Time	t_{on}		—	60	—	
	Fall Time	t_f		—	65	—	
	Turn-off Time	t_{off}		—	220	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}$ $I_D = 60 \text{ A}$	—	170	—	nC
Gate-Source Charge		Q_{gs}		—	110	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	60	—	

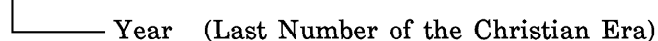
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

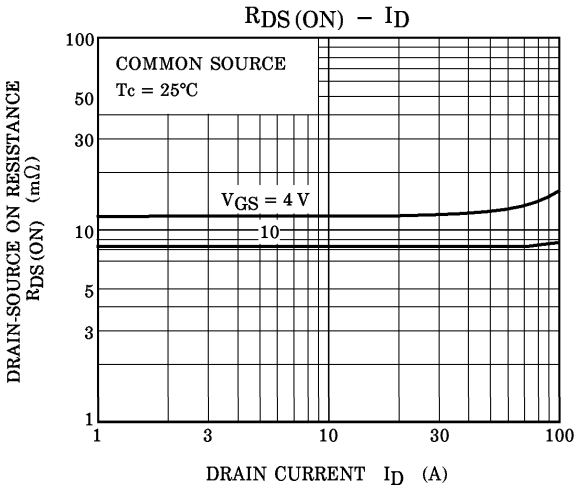
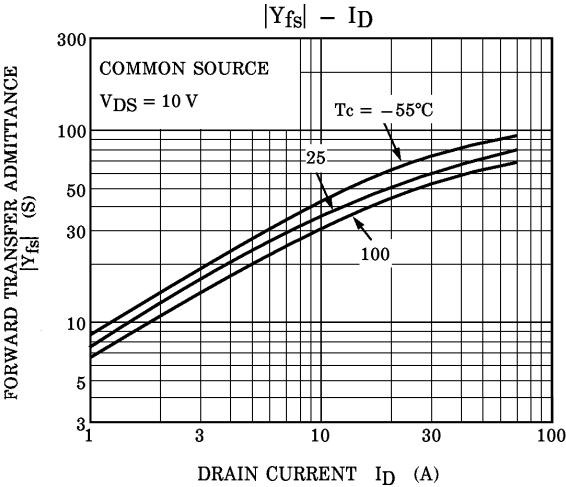
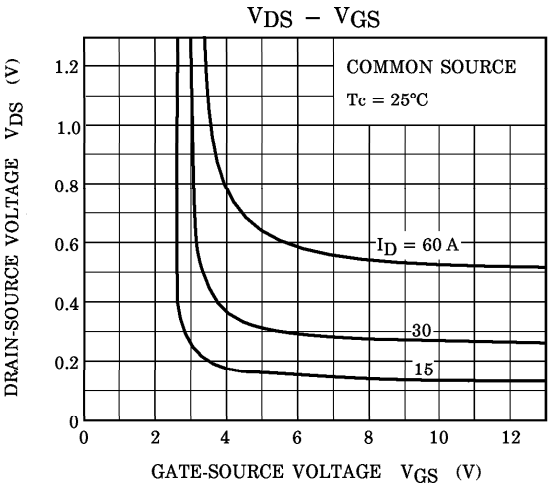
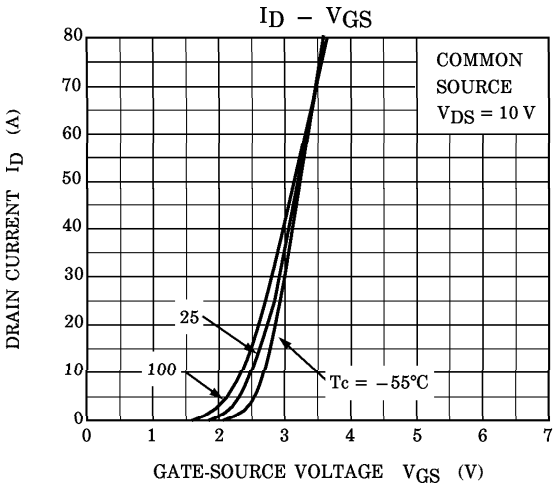
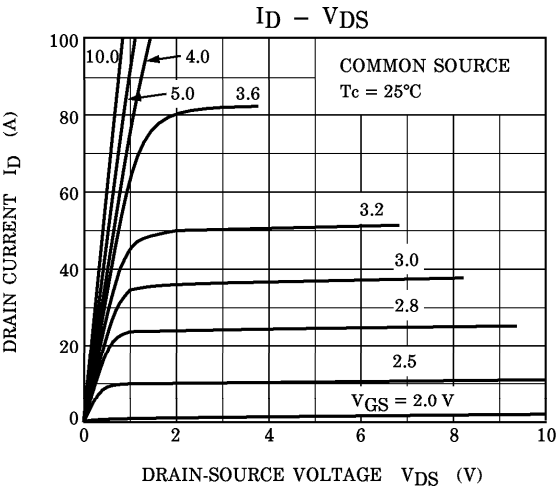
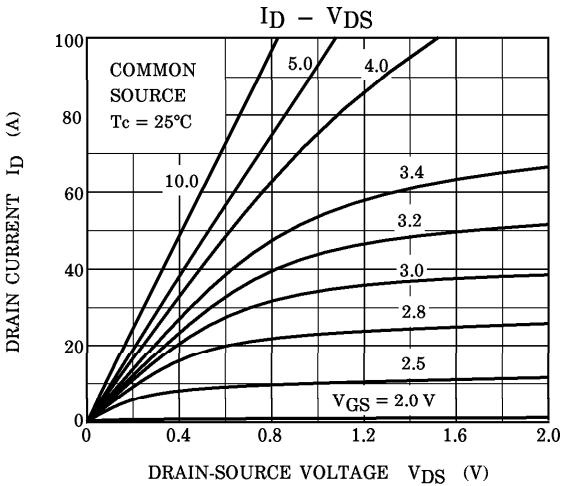
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	60	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	240	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = 60 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	—1.7	V
Reverse Recovery Time	t_{rr}	$I_{DR} = 60 \text{ A}, V_{GS} = 0 \text{ V}$ $dI_{DR}/dt = 50 \text{ A}/\mu\text{s}$	—	150	—	ns
Reverse Recovery Charge	Q_{rr}		—	0.3	—	μC

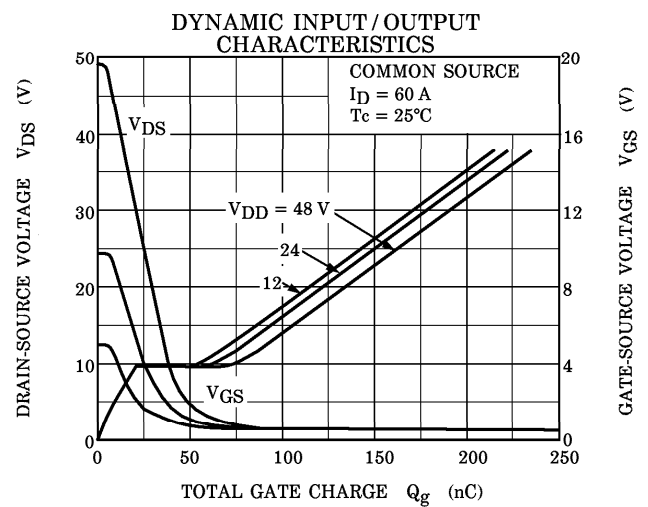
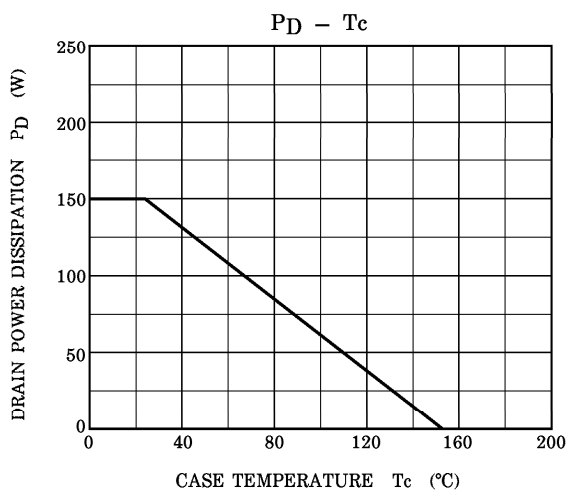
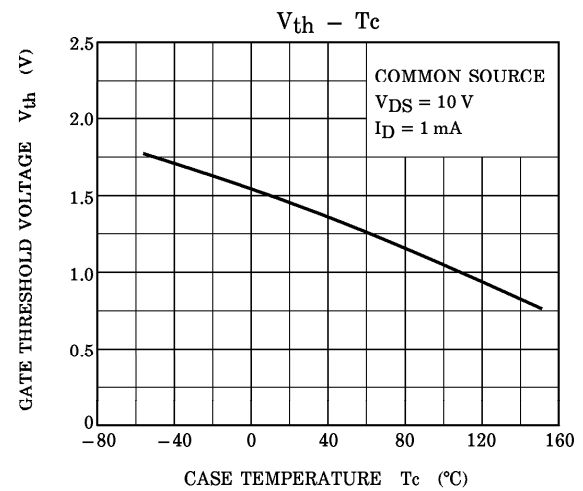
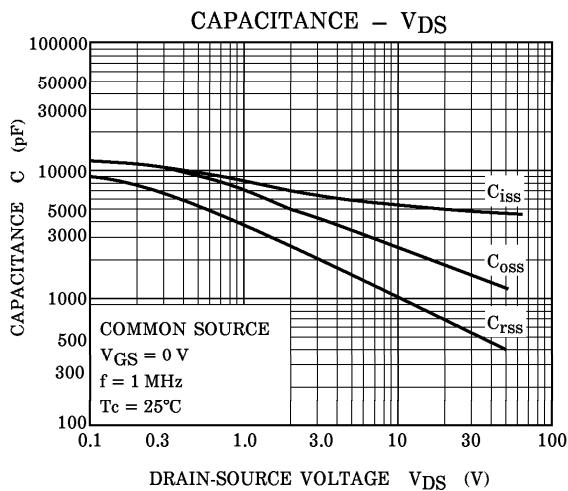
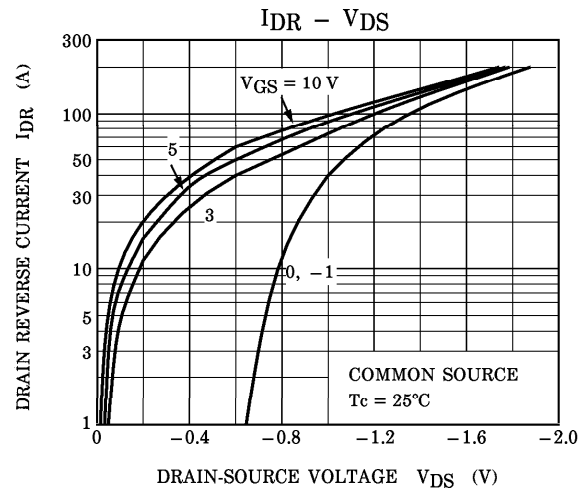
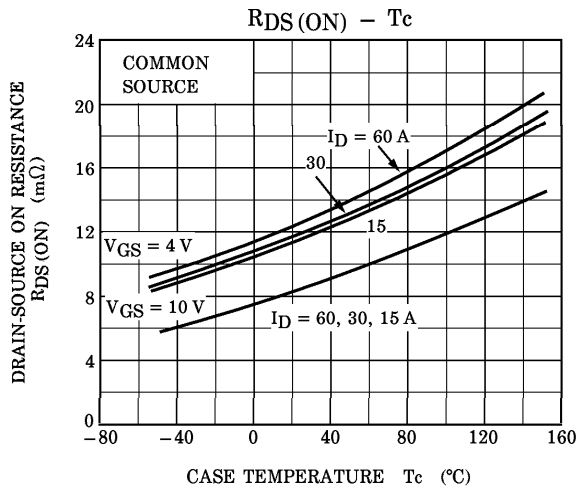
MARKING

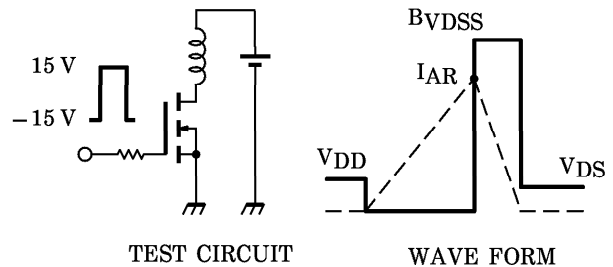
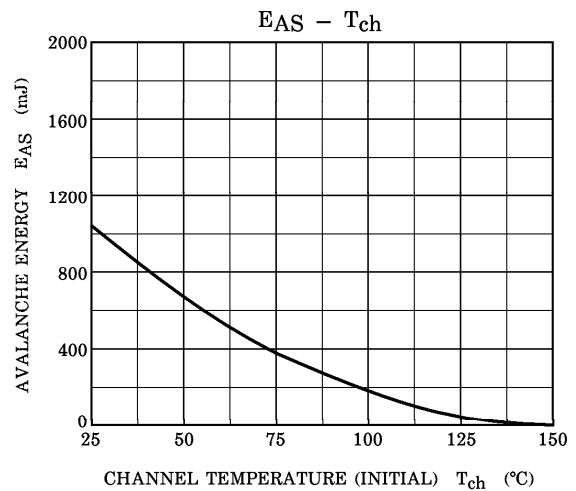
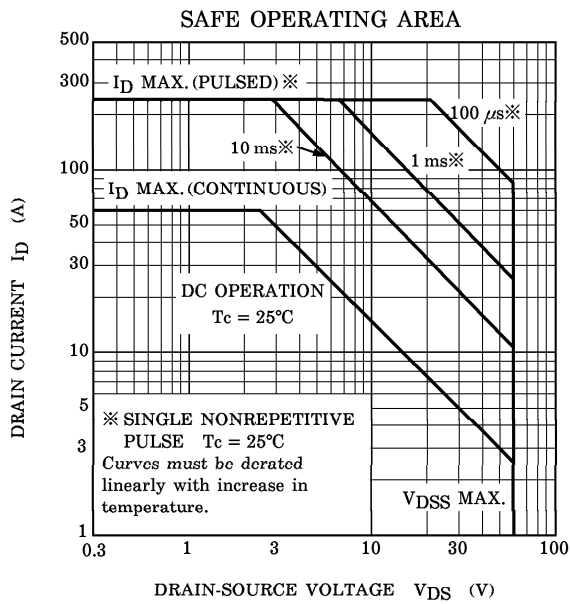
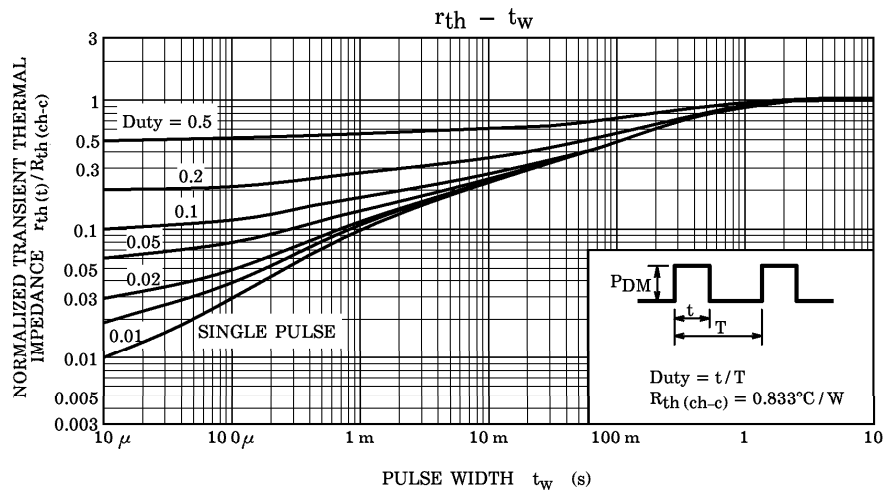


※ Lot Number







Peak $I_{AR} = 60 \text{ A}$, $R_G = 25 \Omega$, $V_{DD} = 25 \text{ V}$, $L = 398 \mu\text{H}$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$